

BCcomponents

# DATA SHEET

150 CLZ

**Aluminum electrolytic capacitors SMD  
(Chip)**

**Long life base plate, very low  
impedance**

Preliminary specification

Supersedes data of 26th September 2001

File under BCcomponents, BC01

2002 Feb 27

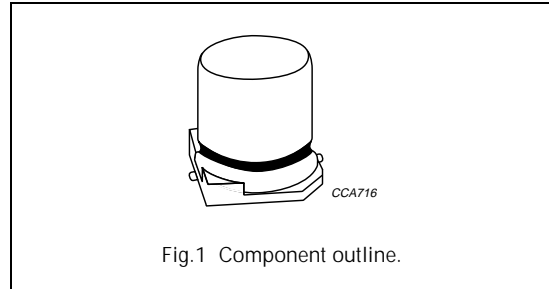
**BC** COMPONENTS

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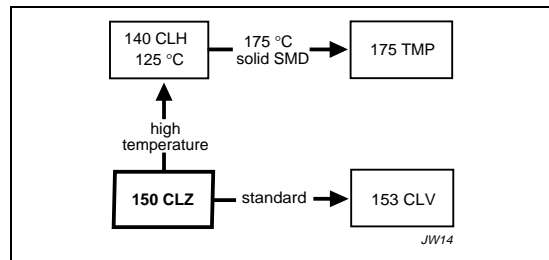
**FEATURES**

- Polarized aluminum electrolytic capacitors, non-solid electrolyte, self healing
- SMD-version with base plate, reflow solderable
- Very low impedance, very high ripple current
- Very long useful life: 3000 hours at 105 °C
- Charge and discharge proof, no peak current limitation
- Supplied in blister tape on reel.



**APPLICATIONS**

- SMD technology, for high mounting density
- Industrial and professional applications
- Automotive, general industrial
- Smoothing, filtering, buffering.



**QUICK REFERENCE DATA**

DESCRIPTION	VALUE
Nominal case sizes (L × W × H in mm)	8 × 8 × 10 to 10 × 10 × 14
Rated capacitance range, C <sub>R</sub>	33 to 1 000 μF
Tolerance on C <sub>R</sub>	±20%
Rated voltage range, U <sub>R</sub>	6.3 to 63 V
Category temperature range	-55 to +105 °C
Endurance test at 105 °C:	2 000 hours
Useful life at 105 °C:	
case size ≤10 × 10 × 10	2 500 hours
case size 10 × 10 × 14	3 000 hours
Useful life at 40 °C; 1.8 × I <sub>R</sub> applied:	
case size ≤10 × 10 × 10	125 000 hours
case size 10 × 10 × 14	150 000 hours
Shelf life at 0 V, 105 °C	1 000 hours
Based on sectional specification	IEC 60384-18/CECC32300
Climatic category IEC 60068	55/105/56

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### 150 CLZ

Selection chart for  $C_R$ ,  $U_R$  and relevant nominal case sizes (L × W × H in mm)

Preferred types in **bold**.

$C_R$ ( $\mu\text{F}$ )	$U_R$ (V)						
	6.3	10	16	25	35	50	63
33	–	–	–	–	–	–	8 × 8 × 10
47	–	–	–	–	–	–	<b>8 × 8 × 10</b>
	–	–	–	–	–	–	<b>10 × 10 × 10</b>
68	–	–	–	–	–	8 × 8 × 10	10 × 10 × 10
<b>100</b>	–	–	–	–	<b>8 × 8 × 10</b>	<b>10 × 10 × 10</b>	10 × 10 × 14
150	–	–	–	8 × 8 × 10	–	–	–
<b>220</b>	–	–	8 × 8 × 10	<b>8 × 8 × 10</b>	<b>10 × 10 × 10</b>	<b>10 × 10 × 14</b>	–
<b>330</b>	–	8 × 8 × 10	<b>8 × 8 × 10</b>	10 × 10 × 10	10 × 10 × 14	–	–
<b>470</b>	8 × 8 × 10	<b>8 × 8 × 10</b>	<b>10 × 10 × 10</b>	<b>10 × 10 × 14</b>	–	–	–
680	–	10 × 10 × 10	10 × 10 × 14	–	–	–	–
<b>1000</b>	10 × 10 × 10	<b>10 × 10 × 14</b>	–	–	–	–	–

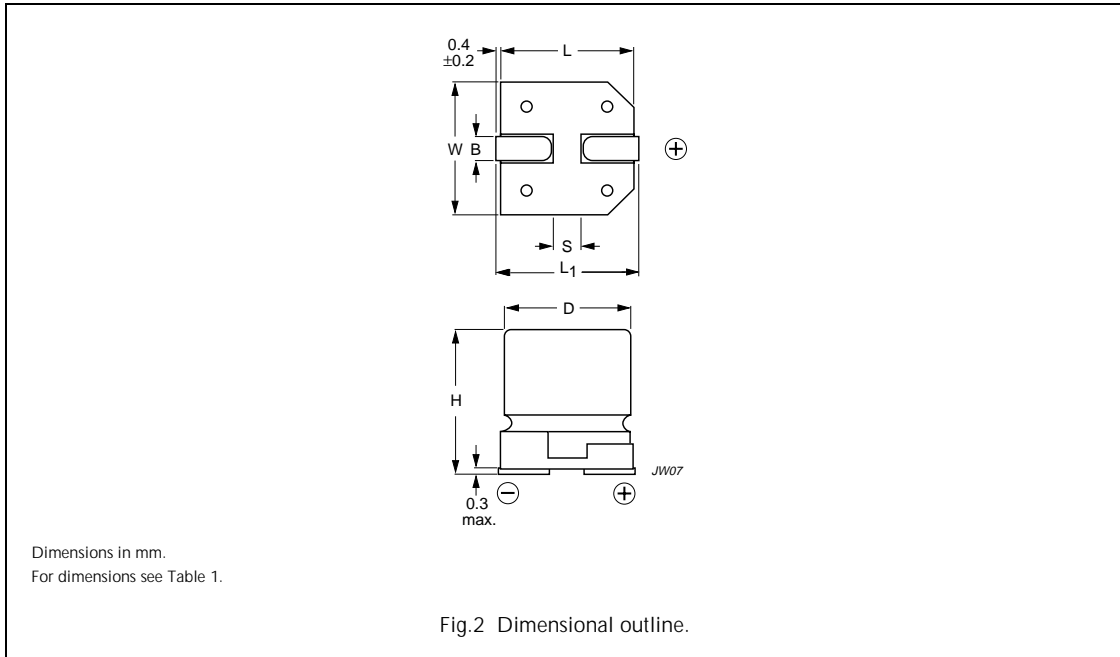
#### MARKING

- Rated capacitance (in  $\mu\text{F}$ )
- Rated voltage (in V)
- Black mark or '–' sign indicating the cathode (the anode is identified by bevelled edges)
- Code indicating group number (Z)
- Date code, in accordance with "IEC 60062".

**Aluminum electrolytic capacitors SMD (Chip)**  
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**150 CLZ**

**MECHANICAL DATA**



**Table 1** Physical dimensions, mass and packaging quantities; see Fig.2

NOMINAL CASE SIZE L × W × H (mm)	CASE CODE	L <sub>max</sub> (mm)	W <sub>max</sub> (mm)	H <sub>max</sub> (mm)	∅D (mm)	B <sub>max</sub> (mm)	S (mm)	L <sub>1 max</sub> (mm)	MASS (g)
8 × 8 × 10	0810	8.5	8.5	10.5	8.0	1.0	3.1	9.9	≈1.0
10 × 10 × 10	1010	10.5	10.5	10.5	10.0	1.0	4.5	11.8	≈1.3
10 × 10 × 14	1014	10.5	10.5	14.3	10.0	1.0	4.5	11.8	≈1.5

**PACKAGING**

Supplied in blister tape on reel. For general packaging information refer to data handbook BC01, section "Packaging".

**Table 2** Tape and reel dimensions

NOMINAL CASE SIZE L × W × H (mm)	CASE CODE	PITCH P <sub>1</sub> (mm)	TAPE WIDTH W (mm)	TAPE THICKNESS T <sub>2</sub> (mm)	REEL DIA. (mm)	PACKAGING QUANTITY PER REEL
8 × 8 × 10	0810	16	24	11.8	380	500
10 × 10 × 10	1010	16	24	11.8	380	500
10 × 10 × 14	1014	16	24	15.0	330	250

**Aluminum electrolytic capacitors SMD (Chip)**  
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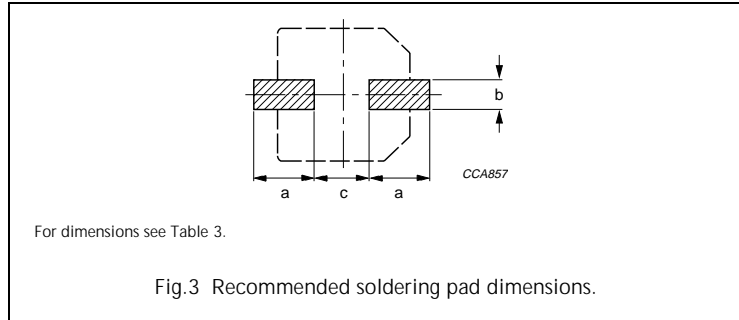
**150 CLZ**

**MOUNTING**

The capacitors are designed for automatic placement on to printed-circuit boards.

Optimum dimensions of soldering pads depend amongst others on soldering method, mounting accuracy, print lay-out and/or adjacent components.

For recommended soldering pad dimensions, refer to Fig.3 and Table 3



For dimensions see Table 3.

Fig.3 Recommended soldering pad dimensions.

**Soldering**

Soldering conditions are defined by the curve, temperature versus time, where the temperature is that measured on the soldering pad during processing.

For maximum conditions refer to Fig.4.

Any temperature versus time curve which does not exceed the specified maximum curves may be applied.

AS A GENERAL PRINCIPLE, TEMPERATURE AND DURATION SHALL BE THE **MINIMUM** NECESSARY REQUIRED TO ENSURE GOOD SOLDERING CONNECTIONS. HOWEVER, THE SPECIFIED MAXIMUM CURVES SHOULD NEVER BE EXCEEDED.

**Table 3** Recommended soldering pad dimensions; see Fig.3

CASE CODE	a (mm)	b (mm)	c (mm)
0810	3.5	2.5	3.0
1010	4.3	2.5	4.0
1014	4.3	2.5	4.0

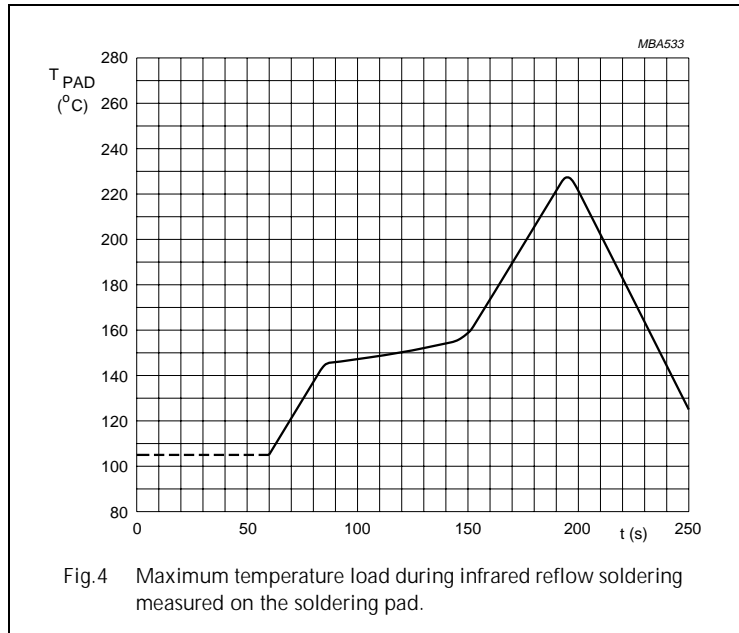


Fig.4 Maximum temperature load during infrared reflow soldering measured on the soldering pad.

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### 150 CLZ

#### ELECTRICAL DATA AND ORDERING INFORMATION

Unless otherwise specified, all electrical values in Table 4 apply at  $T_{amb} = 20\text{ °C}$ ,  
P = 86 to 106 kPa, RH = 45 to 75%.

Electrolytic capacitor 150 CLZ series

220  $\mu\text{F}/50\text{ V}$ ;  $\pm 20\%$

Nominal case size:

10  $\times$  10  $\times$  14 mm; taped on reel

Catalogue number: 2222 150 95102.

SYMBOL	DESCRIPTION
$C_R$	rated capacitance at 100 Hz, tolerance $\pm 20\%$
$I_R$	rated RMS ripple current at 100 kHz, 105 °C
$I_{L2}$	max. leakage current after 2 minutes at $U_R$
Tan $\delta$	max. dissipation factor at 100 Hz
Z	max. impedance at 100 kHz

#### Ordering example

**Table 4** Electrical data and ordering information; preferred types in **bold**

$U_R$ (V)	$C_R$ ( $\mu\text{F}$ )	NOMINAL CASE SIZE L $\times$ W $\times$ H (mm)	$I_R$ 105 °C (mA) 100 kHz	$I_{L2}$ 2 min ( $\mu\text{A}$ )	Tan $\delta$ 100 Hz	Z 100 kHz +20 °C ( $\Omega$ )	CATALOGUE NUMBER 2222 150 .....
6.3	470	8 $\times$ 8 $\times$ 10	435	30	0.24	0.25	95311
	1000	10 $\times$ 10 $\times$ 10	670	63	0.24	0.13	95301
10	330	8 $\times$ 8 $\times$ 10	435	33	0.20	0.25	95411
	<b>470</b>	<b>8 <math>\times</math> 8 <math>\times</math> 10</b>	435	47	0.20	0.25	<b>95412</b>
	680	10 $\times$ 10 $\times$ 10	670	68	0.20	0.13	95401
	<b>1000</b>	<b>10 <math>\times</math> 10 <math>\times</math> 14</b>	850	100	0.20	0.10	<b>95402</b>
16	220	8 $\times$ 8 $\times$ 10	435	35	0.16	0.25	95511
	<b>330</b>	<b>8 <math>\times</math> 8 <math>\times</math> 10</b>	435	53	0.16	0.25	<b>95512</b>
	<b>470</b>	<b>10 <math>\times</math> 10 <math>\times</math> 10</b>	670	75	0.16	0.13	<b>95501</b>
	680	10 $\times$ 10 $\times$ 14	850	109	0.16	0.10	95502
25	150	8 $\times$ 8 $\times$ 10	420	38	0.14	0.28	95611
	<b>220</b>	<b>8 <math>\times</math> 8 <math>\times</math> 10</b>	420	55	0.14	0.28	<b>95612</b>
	330	10 $\times$ 10 $\times$ 10	640	83	0.14	0.14	95601
	<b>470</b>	<b>10 <math>\times</math> 10 <math>\times</math> 14</b>	820	118	0.14	0.11	<b>95602</b>
35	<b>100</b>	<b>8 <math>\times</math> 8 <math>\times</math> 10</b>	405	35	0.12	0.30	<b>95011</b>
	<b>220</b>	<b>10 <math>\times</math> 10 <math>\times</math> 10</b>	630	77	0.12	0.15	<b>95001</b>
	330	10 $\times$ 10 $\times$ 14	790	116	0.12	0.12	95002
50	68	8 $\times$ 8 $\times$ 10	333	34	0.12	0.48	95111
	<b>100</b>	<b>10 <math>\times</math> 10 <math>\times</math> 10</b>	490	50	0.12	0.24	<b>95101</b>
	<b>220</b>	<b>10 <math>\times</math> 10 <math>\times</math> 14</b>	620	110	0.12	0.19	<b>95102</b>
63	33	8 $\times$ 8 $\times$ 10	270	21	0.10	0.65	95812
	<b>47</b>	<b>8 <math>\times</math> 8 <math>\times</math> 10</b>	270	30	0.10	0.65	<b>95811</b>
	<b>47</b>	<b>10 <math>\times</math> 10 <math>\times</math> 10</b>	390	30	0.10	0.38	<b>95801</b>
	68	10 $\times$ 10 $\times$ 10	390	43	0.10	0.38	95802
	100	10 $\times$ 10 $\times$ 14	507	63	0.10	0.29	95803

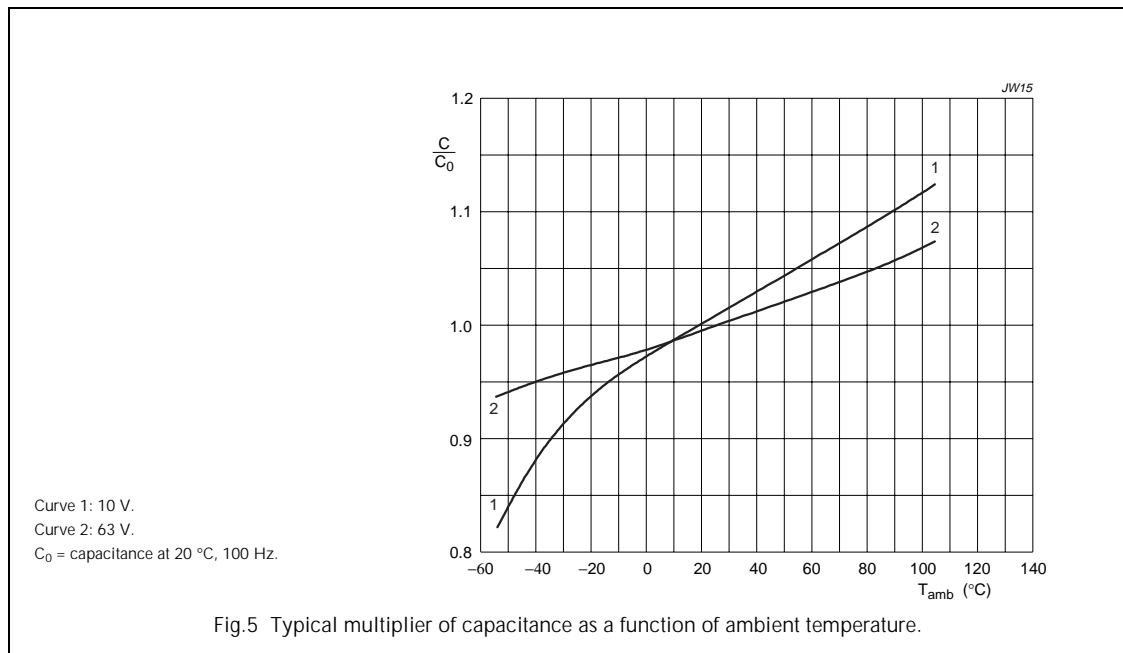
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### 150 CLZ

#### Additional electrical data

PARAMETER	CONDITIONS	VALUE
<b>Voltage</b>		
Surge voltage for short periods	IEC 60384-18, subclause 4.14	$U_s \leq 1.15 \times U_R$
Reverse voltage for short periods	IEC 60384-18, subclause 4.16	$U_{rev} \leq 1 \text{ V}$
<b>Current</b>		
Leakage current	after 2 minutes at $U_R$	$I_{L2} \leq 0.01 \times C_R \times U_R$
<b>Inductance</b>		
Equivalent series inductance (ESL)		typ. 16 nH
<b>Resistance</b>		
Equivalent series resistance (ESR) at 100 Hz	calculated from $\tan \delta_{max}$ and $C_R$ (see Table 4)	$ESR = \tan \delta / 2\pi f C_R$

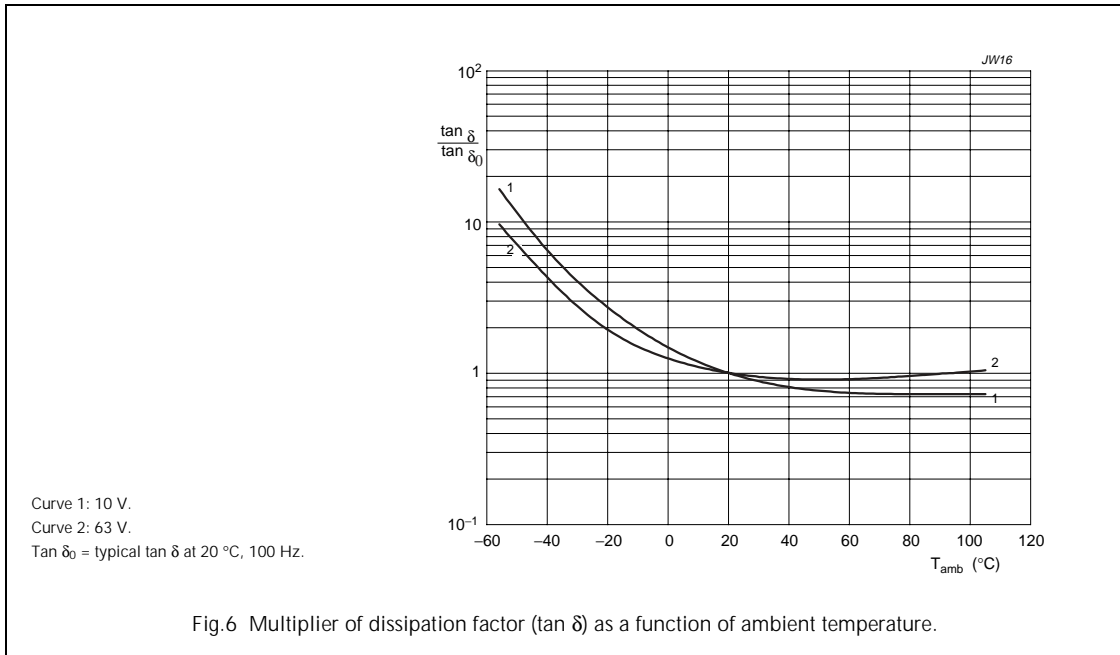
#### Capacitance (C)



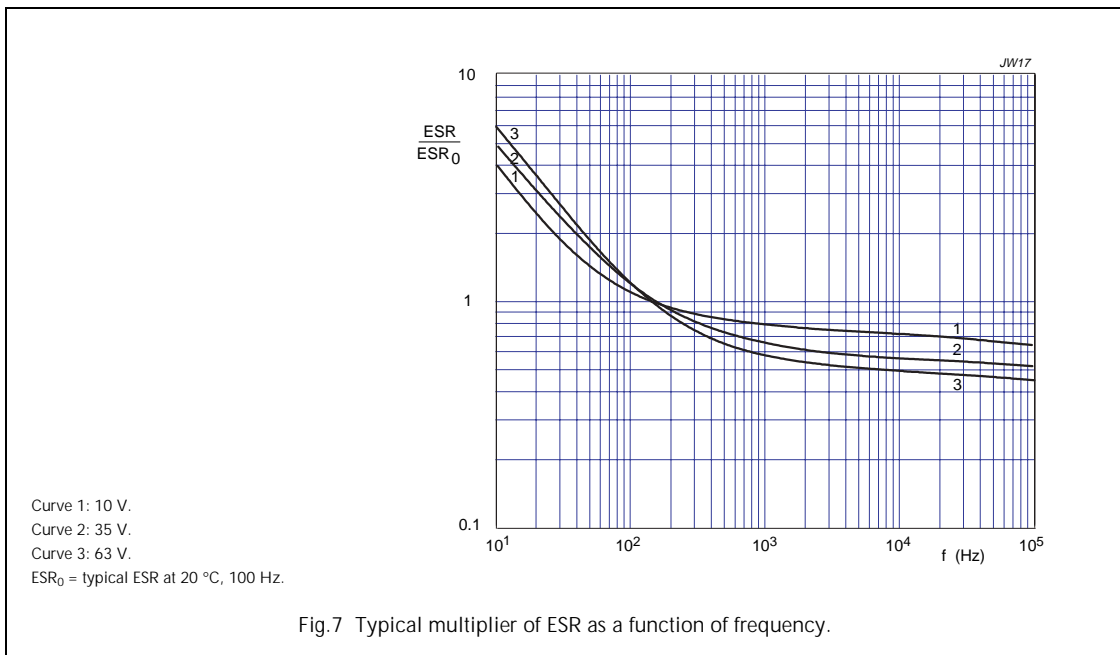
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**150 CLZ**

**Dissipation factor ( $\tan \delta$ )**



**Equivalent series resistance (ESR)**

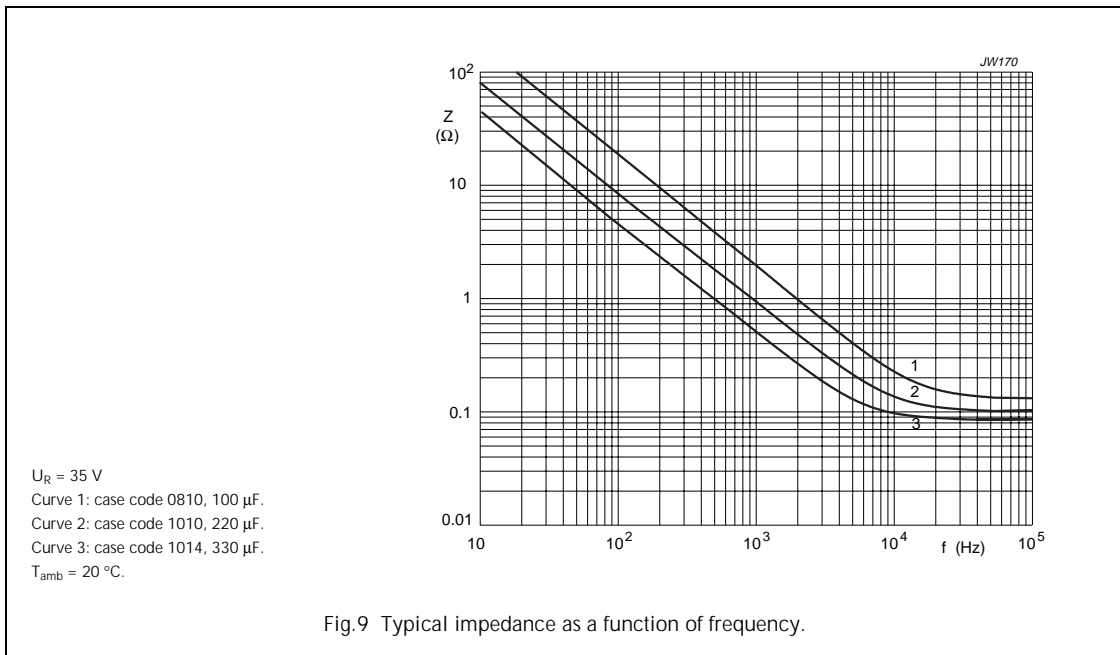
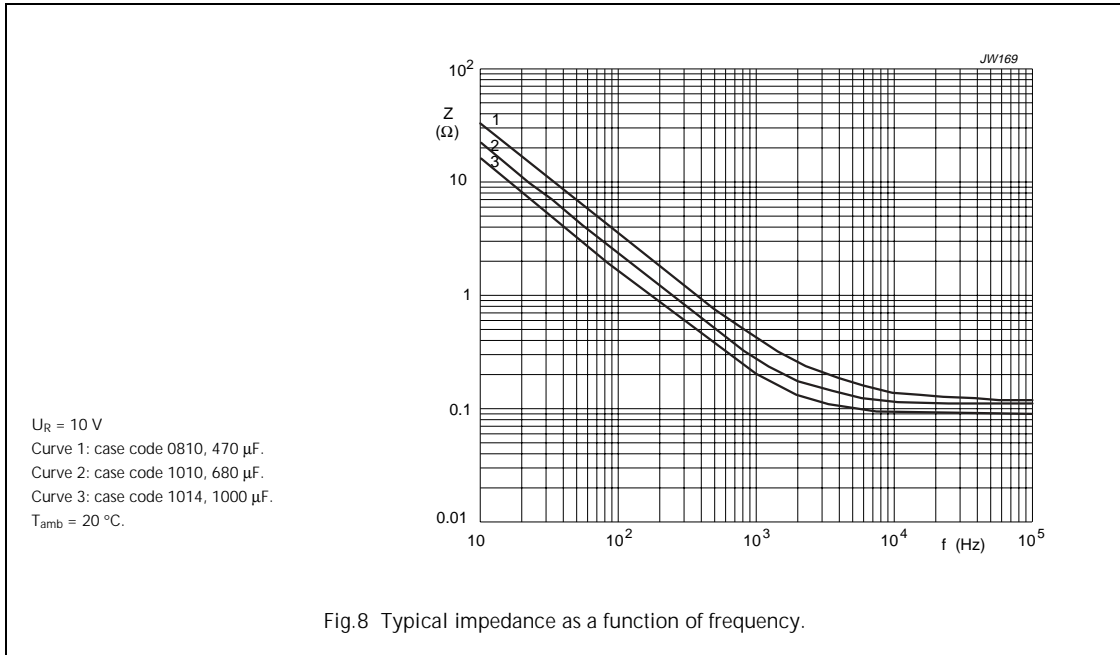




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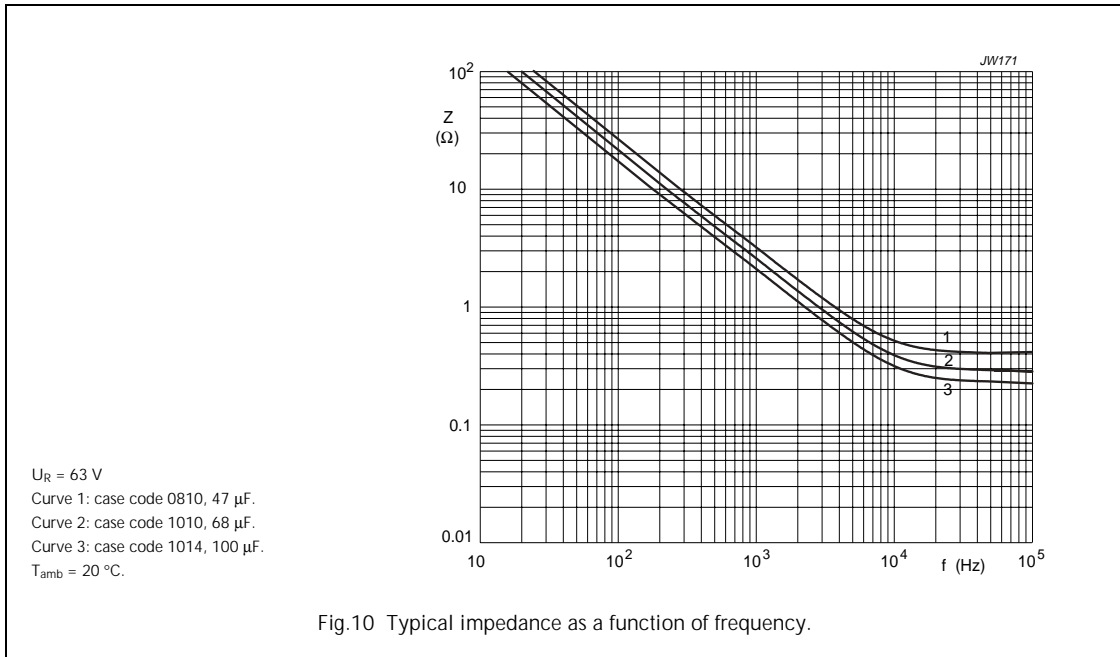
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**Impedance (Z)**



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**150 CLZ**



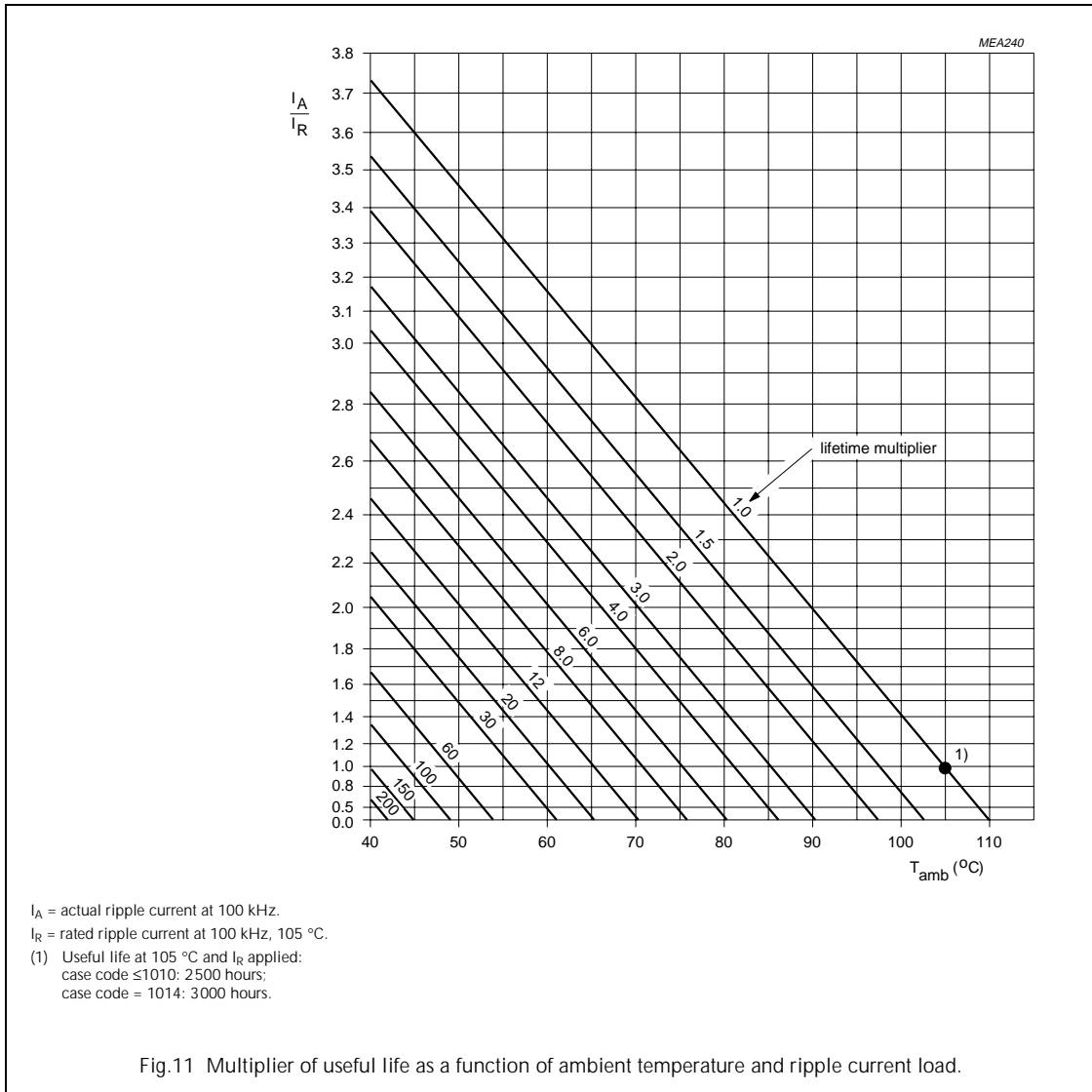
**RIPPLE CURRENT AND USEFUL LIFE**

**Table 5** Multiplier of ripple current (I<sub>R</sub>) as a function of frequency

FREQUENCY (Hz)	I <sub>R</sub> MULTIPLIER		
	U <sub>R</sub> = 6.3 to 25 V	U <sub>R</sub> = 35 V	U <sub>R</sub> = 50 to 63 V
100	0.70	0.65	0.60
300	0.80	0.80	0.75
1000	0.85	0.85	0.85
3000	0.93	0.93	0.93
10000	0.95	0.95	0.95
30000	0.97	0.97	0.97
100000	1.00	1.00	1.00

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### 150 CLZ

#### SPECIFIC TESTS AND REQUIREMENTS

General tests and requirements are specified in data handbook BC01, section "Tests and Requirements".

**Table 6** Test procedures and requirements

TEST		PROCEDURE (quick reference)	REQUIREMENTS
NAME OF TEST	REFERENCE		
Mounting	IEC 60384-18, subclause 4.3	shall be performed prior to tests mentioned below; reflow soldering; for maximum temperature load refer to chapter "Mounting"	$\Delta C/C: \pm 5\%$ $\tan \delta \leq \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$
Endurance	IEC 60384-18/ CECC32300, subclause 4.15	$T_{\text{amb}} = 105 \text{ }^\circ\text{C}$ ; $U_R$ applied; 2000 hours	$U_R = 6.3 \text{ V}$ ; $\Delta C/C: \pm 25\%$ $U_R \geq 10 \text{ V}$ ; $\Delta C/C: \pm 20\%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$
Useful life	CECC 30301, subclause 1.8.1	$T_{\text{amb}} = 105 \text{ }^\circ\text{C}$ ; $U_R$ and $I_R$ applied; case size $\leq 10 \times 10 \times 10$ : 2 500 hours case size = $10 \times 10 \times 14$ : 3 000 hours,	$\Delta C/C: \pm 50\%$ $\tan \delta \leq 3 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ no short or open circuit total failure percentage: $\leq 1\%$
Shelf life (storage at high temperature)	IEC 60384-18/ CECC32300, subclause 4.17	$T_{\text{amb}} = 105 \text{ }^\circ\text{C}$ ; no voltage applied; 1000 hours  after test: $U_R$ to be applied for 30 minutes, 24 to 48 hours before measurement	for requirements see 'Endurance test' above